

**PATENT ASSIGNMENT**

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SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
<b>CONVEYING PARTY DATA</b>													
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Satoshi IBORI</td> <td>09/01/2009</td> </tr> <tr> <td>Yasushi SASAKI</td> <td>09/01/2009</td> </tr> <tr> <td>Yutaka MAENO</td> <td>09/01/2009</td> </tr> <tr> <td>Masayuki HIROTA</td> <td>09/01/2009</td> </tr> <tr> <td>Kazuyuki FUKUSHIMA</td> <td>09/01/2009</td> </tr> </tbody> </table>		Name	Execution Date	Satoshi IBORI	09/01/2009	Yasushi SASAKI	09/01/2009	Yutaka MAENO	09/01/2009	Masayuki HIROTA	09/01/2009	Kazuyuki FUKUSHIMA	09/01/2009
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<b>RECEIVING PARTY DATA</b>													
Name:	Hitachi Industrial Equipment Systems Co., Ltd.												
Street Address:	AKS Building, 3, Kanda Neribeicho, Chiyoda-ku												
City:	Tokyo												
State/Country:	JAPAN												
<b>PROPERTY NUMBERS Total: 1</b>													
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>12537281</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	12537281								
Property Type	Number												
Application Number:	12537281												
<b>CORRESPONDENCE DATA</b>													
Fax Number:	(703)684-1157												
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NAME OF SUBMITTER:	John R. Mattingly												
Total Attachments: 1													

CH \$40.00 12537281

**500968725**

**PATENT  
 REEL: 023265 FRAME: 0548**



ASSIGNMENT

(讓渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Hitachi Industrial Equipment Systems Co., Ltd. a corporation organized under the laws of Japan, located at AKS Building, 3, Kanda Neribeicho, Chiyoda-ku, Tokyo, Japan receipt of which is hereby acknowledged I do hereby sell and assign to said Hitachi Industrial Equipment Systems Co., Ltd. its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

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invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said Hitachi Industrial Equipment Systems Co., Ltd. its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi Industrial Equipment Systems Co., Ltd.

Signed on the date(s) indicated aside our signatures:

INVENTOR(S) (發明者フルネームサイン)		Date Signed (署名日)
1)	<u>Satoshi IBORI</u> Satoshi IBORI	<u>Sep. 1, 2009</u>
2)	<u>Yasushi SASAKI</u> Yasushi SASAKI	<u>Sep. 1, 2009</u>
3)	<u>Yutaka MAENO</u> Yutaka MAENO	<u>Sep. 1, 2009</u>
4)	<u>Masayuki HIROTA</u> Masayuki HIROTA	<u>Sep. 1, 2009</u>
5)	<u>Kazuyuki FUKUSHIMA</u> Kazuyuki FUKUSHIMA	<u>Sep. 1, 2009</u>
6)	_____	_____
7)	_____	_____
8)	_____	_____
9)	_____	_____
10)	_____	_____